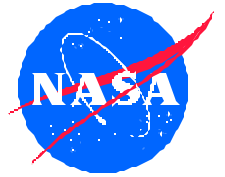


STABLCOR Printed Circuit Boards

*Applied Material Technologies, Inc.
Santa Ana, CA*



INNOVATION

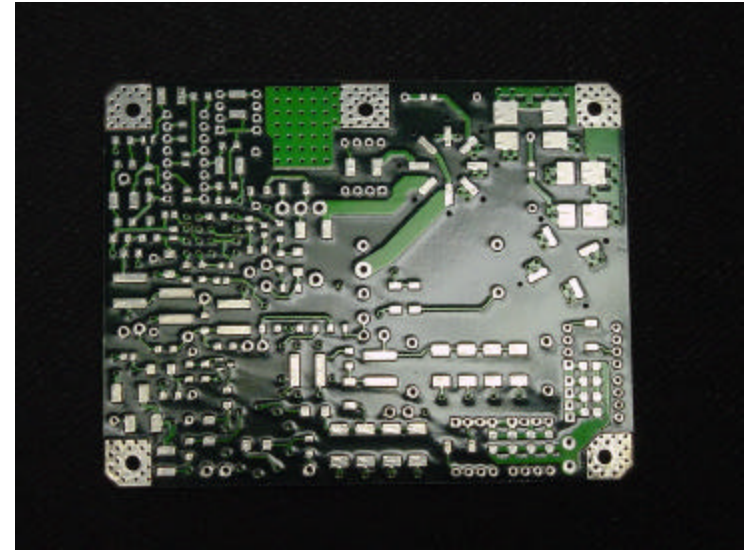
Printed circuit board with a high conductivity and low thermal expansion core material

ACCOMPLISHMENTS

- ◆ Developed a printed circuit board that improves thermal heat dissipation and reduces thermal expansion mismatch between the board and the integrated circuit components
- ◆ Prototype units manufactured and qualification tested by Boeing Commercial Space Systems
- ◆ Manufacturing process developed and transitioned to production at a commercial manufacturing facility

COMMERCIALIZATION

- ◆ AMT has sold an exclusive license to SDC Circuits for cash plus revenues related to future sales
- ◆ \$50K authorized and spent to conduct qualification life tests
- ◆ A strategic alliance between AMT, SDC Circuits and Ramtek, Inc. has been formed for servicing the memory and computer markets
- ◆ SDC Circuits has spent approximately \$1M on manufacturing development of the production process
- ◆ Discussions with venture firms indicate a potential for \$20M investment



Printed Circuit Board with New Core Material

- ◆ Primary commercial interest to date is from the high data storage memory markets and from server markets

GOVERNMENT/SCIENCE APPLICATIONS

- ◆ Interest from government has been for space and military systems
- ◆ This technology is useful for other science applications

Glenn Research Center
Space Power
3-076

1995 Phase II, NAS3-97040, 11/01
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